## INDIAN INSTITUTE OF INFORMATION TECHNOLOGY DESIGN AND MANUFACTURING (IIITDM) KANCHEEPURAM

## INTRODUCTION OF NEW COURSE

Course Title	Materials Fabrication and Characterization Techniques	Course No	PH5102				
Department/	Materials Science, Mechanical,	Credits	L		Т	Р	С
Specialization	Electronic and Design Engineering	Chatura	3		1 Flaatin	0	4
Offered for	UG, PG/DD and PhD	Status	Core		Electiv	'e	
the course	Dr. Y. Ashok Kumar Reddy	Туре	New		Revisio	on	
Recommendation from the DAC		Date of DAC	12-07-22 (Approved in $38^{th}$ senate with 3 credits)				
External Expert(s)	1. Dr. K.R. Gunasekhar, Principle Scientist, IISc Bangalore, 2. Prof. S.P. Venkateshan, Professor Emeritus, IIT Madras & 3. Dr. Dr Annapureddy V., NIT Trichy						
Prerequisite	Consent of Teacher (COT)	Submitted for a	oproval	48 Senate			
Learning Objectives	<ul> <li>To know the deposition techniques for the manufacture of products</li> <li>To study the physical, morphological and chemical properties</li> </ul>						
Learning Outcomes	<ul> <li>This course aims to learn the different techniques to fabricate the device samples</li> <li>It can be mainly useful for PG, DD and as well as PhD students towards making the products and study the basic properties of the synthesized samples</li> </ul>						
Course Contents (with approximate breakup of hours for lecture/ tutorial/practice)	<ul> <li>I. Preparation of Thin Films</li> <li>A. Vacuum basics: Production of Vacuum, Pressure measurement Gauges in Vacuum system <i>Tutorial: Lab visit (Hands-on): Operation of Low and High vacuum pumps</i> (5+T2 h)</li> <li>B. Physical methods: Thermal evaporation, Electron beam evaporation, Pulsed laser deposition and Molecular beam epitaxy, Sputtering: DC and RF sputtering, Glow discharge and Reactive magnetron sputtering</li> <li><i>Tutorial: Lab visit (Hands-on): Sputtering, Thermal Evaporation</i> (10+T4 h)</li> <li>C: Chemical methods: Atomic layer deposition, Chemical vapour deposition, Spray pyrolysis and Spin-coating; <i>Tutorial: Lab visit (Hands-on): Chemical vapour deposition</i> (5+T2 h)</li> <li>II. properties and Applications of Thin Films</li> <li>A. Characterization of thin films:</li> <li>Crystallography Technique: X-Ray Diffraction</li> <li>Imaging Techniques: Scanning electron microscopy, Transmission electron microscopy, Atomic force microscopy and Rutherford Backscattering Spectroscopy, X-ray Photo electron Spectroscopy, Raman Spectroscopy, Secondary Ion Mass Spectroscopy</li> <li><i>Tutorial: Lab visit (Hands-on): Origin and Calculations of crystallite size and Band gap</i> (15+T3 h)</li> <li>B. Applications of Thin Films:</li> <li>Photolithography: Photoresists, Mask and pattern generation;</li> <li>Thin film capacitors, diodes and photodetectors; Thin film solar cells, Thin film micro-batteries;</li> <li>Thin film capacitors, diodes and photodetectors; Thin film solar cells, Thin film micro-batteries;</li> <li>Thin film Sensors: Gas sensors, Bolometers</li> <li><i>Tutorial: Lab visit (Hands-on): Photodetector and Gas sensor devices measurements</i> (7+T4 h)</li> </ul>						
Essential Reading	<ol> <li>Materials Science of Thin Films: Deposition and Structure, Milton Ohring , D. Gall, S. P. Baker, Academic Press Inc, 3<sup>rd</sup> ed. 2014.</li> </ol>						

Supplementary	1. Surface Analysis Methods in Materials Science, J. O'Connor, B. Sexton, R.S.C. Smart, Springer-
Reading	Verlag Berlin Heidelberg, 2nd ed. 2003.